

MV cables Tools

MF3NP/40



Section

MV Multifunction

Application

Field
Laboratory



PRODUCT BENEFITS

Tuning of the pitch of the tool

TOOL CAPACITY

Diameter	16 - 40 mm 0,630 - 1,575 inch
Non peelable semiconductor screen thickness capacity	0.4 - 1.4 mm / 0.026 - .06 inch
Insulation thickness capacity	7 mm / 0.28 inch
Chamfer angle on the non peelable semiconductor screen	14.5°

TOOL DIMENSIONS

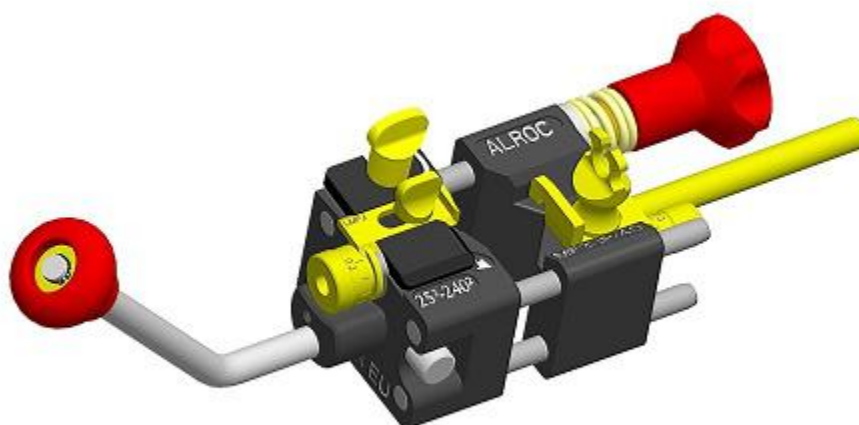
Length	165 mm
Width	80 mm
Height	100 mm
Weight without box	1,03 Kg
Packaging	Box

Multifunction tool for outer sheath, bonded semiconductor and insulation

TO DO WHAT

The MF3NP/60 tools enables the user to :
Remove the outer sheath (PE-PVC-PR) with a straight and neat cut.
Remove the bonded semiconductor with a chamfer and a minimum remaining length of semiconductor of 40 mm / 1.57 inch
Remove the insulation with a neat and straight cut

Silicon required for the removal of bonded semiconductor



Spare part

LMF2 - Spare blade for primary insulation
PCR - Quick set up right angled 45° handle
196855 - Straight handle M10
108098 - Clamping knob for blade
LASCRI - Spare blade for bonded semiconductor

Associated tool

GRI-RTE - Scraper for residues of bonded semiconductor screen with protective case
LHA - Tool to chamfer insulation



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Part Number	Diameter	Tool capacity			Dimensions			Packaging
		Non peelable semiconductor screen thickness capacity	Insulation thickness capacity	Chamfer angle on the non peelable semiconductor screen	Length	Width	Height	
MF3NP/40	16 - 40 mm 0,630 - 1,575 in	0.4 - 1.4 mm / 0.026 - .06 inch	7 mm / 0.28 inch	14.5°	165 mm 6,496 in	80 mm 3,150 in	100 mm 3,937 in	box
MF3NP/60	16 - 58 mm 0,630 - 2,283 in	0.4 - 1.4 mm / 0.026 - .06 inch	7 mm / 0.28 inch	14.5°	185 mm 7,283 in	90 mm 3,543 in	120 mm 4,724 in	none



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